ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Material Composit © Copyright 2005. IPC, I international and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a decla he declaratio	aration on enco	of the sub- mpasses a	stances w all lower	vithin the level mate	manufacture erials for wh	er listed ite	em. Not anufact	te: if the urer has	item is an ass engineering re	embly with lowe sponsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form 7   http://www.ipc.org/IPC-175x Distribution				Form Type Distribute	be * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mate					ous Materia	ials and Mfg Information					
Supplier Informa	tion																
Company name*			Company unique ID				Unique ID Authority					Response Date*					
onsemi													2024-04-30				
Contact Name			Title - Contact				Phone - Contact*						Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA						Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*					Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Requester I	Requester Item Number Mfr Iter		Number Mfr Item Name				Effective D	Date V	Version Manufacturing Site		ing Site	Weight*		:	UOM	Unit Type	
	FDMC7		728	PT7 NCH 30/20V Syncfet ML			2024-04-30	0		Tł	TH2		2	1.076		mg	Each
Manufacturing P	roccess Information	l															
Terminal Plating / Grid Array Material		al T	erminal Base Alloy J-S		J-STD-020 MS	020 MSL Rating		Peak Process Body Tempera		nperature	ture Max Time at Peak T		Femperature Number		umber of	Reflow Cycle	es
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		C		30		seconds 3				
Comments																	
evel 1 - maximum tim	e at peak temperature d	luring sol	dering is 10-3	0 seconds													
or more information	regarding material com	position 1	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.05	mg	Supplier	Silicon (Si)	7440-21-3		1.05	mg
Die Attach	0.198	mg	Supplier	Silver (Ag)	7440-22-4		0.1584	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0396	mg
Lead Frame	7.664	mg	Supplier	Zinc (Zn)	7440-66-6		0.01	mg
			Supplier	Iron (Fe)	7439-89-6		0.184	mg
			Supplier	Copper (Cu)	7440-50-8		7.47	mg
Mold Compound-Black	11.505	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		2.19	mg
			Supplier	Carbon Black (C)	1333-86-4		0.115	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		9.2	mg
Plating	0.198	mg	Supplier	Palladium (Pd)	7440-05-3		0.018	mg
			В	Nickel (Ni)	7440-02-0		0.178	mg
			Supplier	Gold (Au)	7440-57-5		0.002	mg
Wire Bond - Cu	0.461	mg	Supplier	Copper (Cu)	7440-50-8		0.461	mg